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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant

: Martin Hierholzer

Applic. No.

: 10/023,189

Filed

MUH-

: December 17, 2001

Title

: Low-Inductance Semiconductor Components

## PRELIMINARY AMENDMENT

Hon. Commissioner of Patents and Trademarks, Washington, D. C. 20231

## Sir:

Preliminary to the examination, kindly amend the aboveidentified application as follows:

## In the Specification:

The paragraph starting on page 12, line 1 and ending on page 12, line 11 now reads as:

In the case of the switching element 6 adjacent alongside on the right, the current path is produced from top to bottom in exactly the reverse order: the second supply potential 12 at the load current connection element 10 - the lead 9 - the